TAI-SAW TECHNOLOGY CO., LTD.
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Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 2.5x2.0 26.041666MHz

TST Part No.: TZ3211A

Customer Part No.:_____

Customer signature required

Company:_____

Division:_____

Approved by :_____

Date:_____

Checked by: Yifan Chen

Approved by: Kelly Huang

Date: 08/29/2018

1. Customer signed back is required before TST can proceed with sample build and receive orders.
2. Orders received without customer signed back will be regarded as agreement on the specifications.
3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

TAI-SAW TECHNOLOGY CO., LTD.

Crystal Unit SMD 2.5x2.0 26.041666MHz

MODEL NO.: TZ3211A REV. NO.: 3

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	11/11/16’	N/A	Yifan Chen
2	3	Changed ESR and Drive level	05/05/17’	ECN-201700163	Yifan Chen
3	4	Update Marking Rule, Tape/Reel Dimensions	08/29/18’	ECN-201800392	Yifan Chen

TAI-SAW TECHNOLOGY CO., LTD.

Crystal Unit SMD 2.5x2.0 26.041666MHz

MODEL NO.: TZ3211A REV. NO.: 3

Features:

RoHS Compliant
Lead free
Lead-free soldering

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL) : Level-1

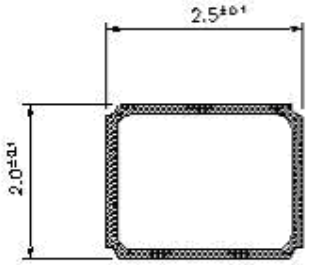
Description and Applications:

Surface mount 2.5mmx2.0mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

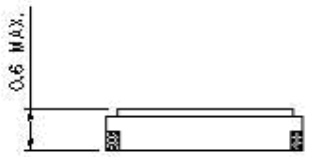
Electrical Specifications:

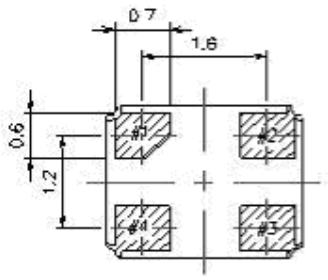
TZ3211A	**Specification**
Nominal Frequency	26.041666 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-55°C to +125°C
Operating Temperature Range	-35°C to +85°C
Frequency Stability over Operating Temperature Range	+/-20 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-20 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	25 Ω max
Nominal Drive Level	10uW typical and 100uW max
Shunt Capacitance (Co)	1.0 typical and 2.0 pF max
Load Capacitance (CL)	9.5 pF
ESR Change due to Drive Level	4 Ω max (1uW to 100uW)
Frequency Shift due to Drive Level	4 ppm max(1uW to 100uW)
Inharmonic Overtones	>3dB down from Main Mode
Aging	+/-3ppm/year , 1st year , then +/-1ppm/year max
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking
Unit Weight	9.5 +/-0.5mg

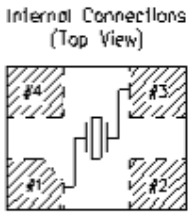
Mechanical Dimensions (mm):



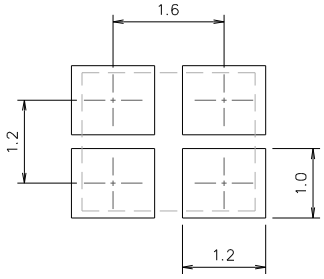
	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND







Recommended Land Pattern: (unit: mm)

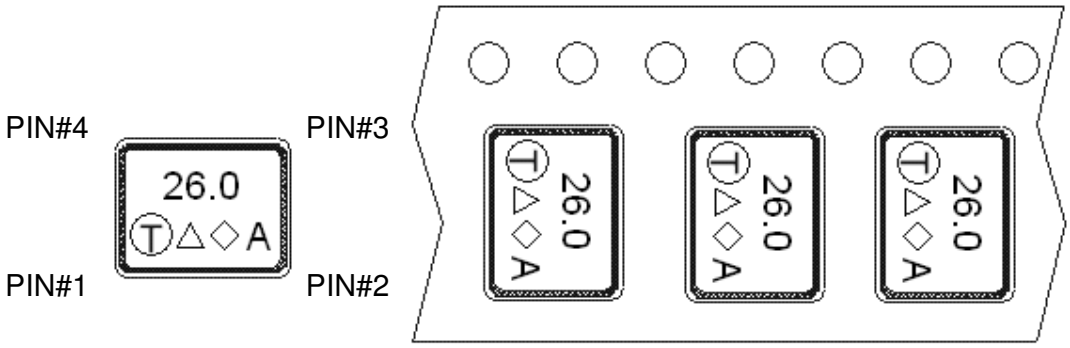


Marking:

Customer Marking

Line 1: Frequency (26.0)

Line 2: TST Logo(Ⓣ) + Date Code (△) + Year Code (◇) + Product Code (A)



The inner vision of PIN#1,PIN#4 side is XTAL blank mounting pad.

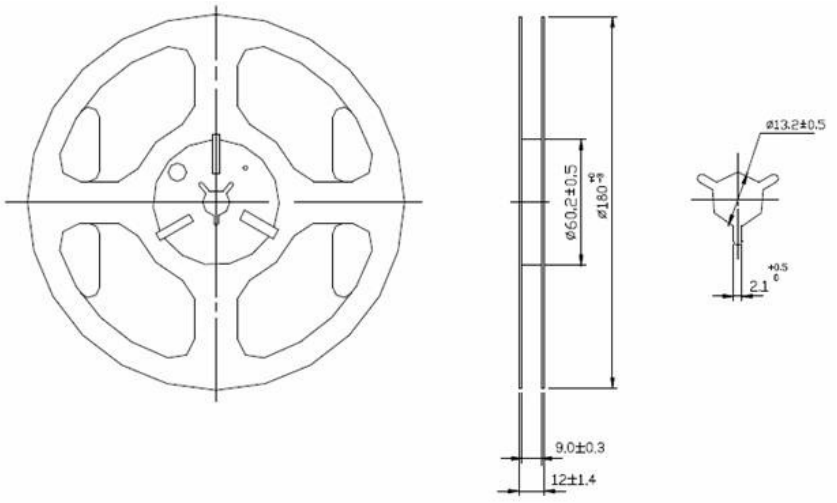
Date Code Table(△)

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	**WK15**	**WK16**	**WK17**	**WK18**	**WK19**	**WK20**	**WK21**	**WK22**	**WK23**	**WK24**	**WK25**	**WK26**
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	**WK28**	**WK29**	**WK30**	**WK31**	**WK32**	**WK33**	**WK34**	**WK35**	**WK36**	**WK37**	**WK38**	**WK39**
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	**WK41**	**WK42**	**WK43**	**WK44**	**WK45**	**WK46**	**WK47**	**WK48**	**WK49**	**WK50**	**WK51**	**WK52**
n	o	p	q	r	s	t	u	v	w	x	y	z

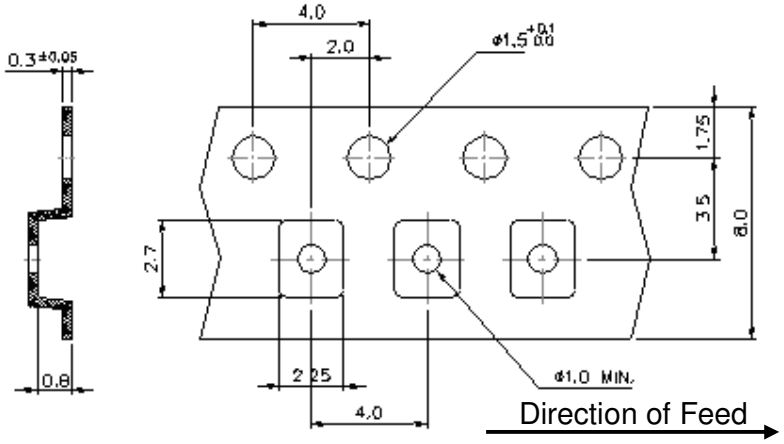
Year Code Table (◇)

Year	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	A	B	C	D	E	F	G	H	I	J
Year	2027	2028	2029	2030	2031	2032	2033	2034	2035	2036
Code	K	L	M	N	O	P	Q	R	S	T
Year	2037	2038	2039	2040	2041	2042				
Code	U	V	W	X	Y	Z				

Reel Dimensions (mm):



Tape Dimensions (mm):

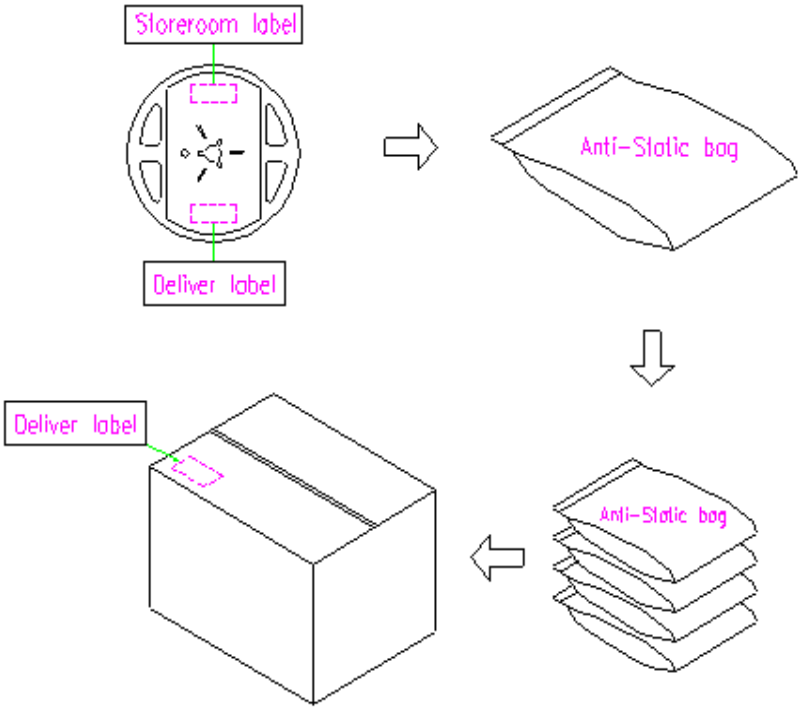


[NOTE]:

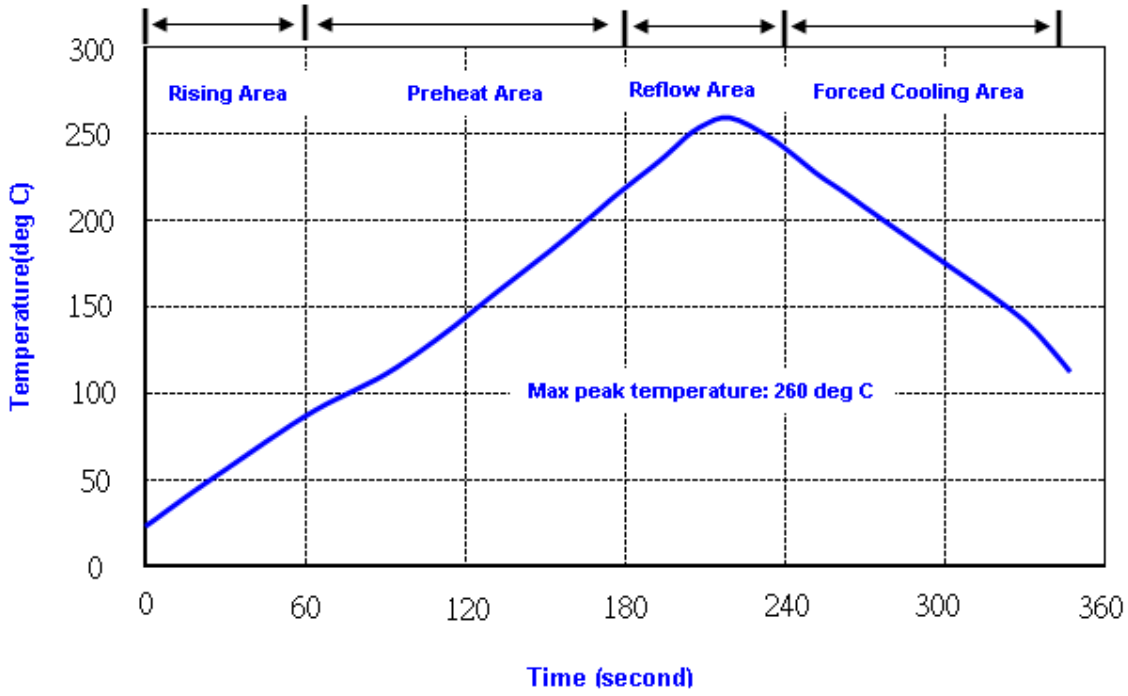
1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: 90~100 sec

Reliability Specifications

Test name	Test process / method	Reference standard
Mechanical characteristics		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular Duration : 2 hr / direc.	MIL-STD 202G method 204
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213
Solderability	Solder Temperature:265±5℃ Duration time: 5±0.5 seconds.	J-STD-002
Environmental characteristics		
Thermal Shock	Heat cycle conditions -40 ℃ (30min) ←→ 85 ℃ (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A
Cold resistance (Low Temp Storage)	Temperature : -40 ± 2 ℃ Duration : 96 hours	IEC 60068-2-1